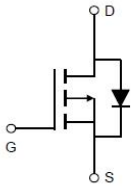
-100V P-Channel Power MOSFET

• General Description

It combines trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. It is suitable for automotive application.

• Product Summary



V_{DS}= -100V

$R_{DS(ON)}$ = 26mΩ

I_D= -54A

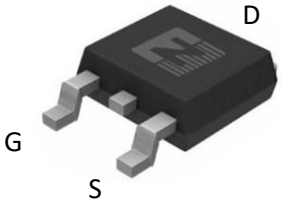
• Features

■AEC-Q101 Qualified

■Low $R_{DS(ON)}$ to minimize conductive loss

■High GOX reliability

■Low Thermal resistance



TO-263

•Application

■DC-DC

■Load Switch

•Ordering Information:

Part NO.	ZMA240P10B
Marking	ZM240P10
Packing Information	REEL TAPE
Basic ordering unit (pcs)	800

•Absolute Maximum Ratings (T_C=25℃)

Parameter	Symbol	Conditions	Value	Unit
Drain-Source Voltage	V_{DS}		-100	V
Gate-Source Voltage①	V_{GS}		±20	V
Continuous Drain Current	I_D	T_C=25℃	-54	A
	I_D	T_C=75℃	-45	A
	I_D	T_C=100℃	-39	A
Pulsed Drain Current	I_{DM}	Pulsed; t_p ≤ 10 μs; T_{mb} = 25 °C;	-216	A
Total Power Dissipation	P_D	T_C=25℃	214	W
Total Power Dissipation	P_D	T_A=25℃	3.8	W
Operating Junction Temperature	T_J		-55 to +175	℃
Storage Temperature	T_{STG}		-55 to +175	℃
Single Pulse Avalanche Energy	E_{AS}	L=0.1mH, V_{GS}=-10V, Rg=25Ω,	200	mJ
		L=0.5mH, V_{GS}=-10V, Rg=25Ω,	420	mJ
ESD Level (HBM)	CLASS 2			

●Thermal resistance

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	R_{thJC}		-	0.7	°C/W
Thermal resistance, junction-ambient②	R_{thJA}		-	40	°C/W
Soldering temperature (total time<10s)	Tsold		-	260	°C

●Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS} =0V, I_D =-250uA	-100			V
Gate Threshold Voltage	$V_{GS(TH)}$	V_{GS} =V_{DS}, I_D =-250uA	-1.3	-1.8	-2.5	V
Drain-Source Leakage Current	I_{DSS}	V_{GS}=0V, V_{DS}= -100V			1.0	uA
Gate- Source Leakage Current	I_{GSS}	V_{GS}=±20V, V_{DS} = 0V			100	nA
Static Drain-source On Resistance	$R_{DS(ON)}$	V_{GS}=-10V, I_D= -16A		26	34	mΩ
		V_{GS}=-4.5V, I_D= -12A		32	41	mΩ
Forward Transconductance	g_{FS}	V_{DS} =-5V, I_{SD} = -10A		40		s
Diode Forward Voltage	V_{FSD}	V_{GS} =0V, I_{SD} = -16A			1.3	V

●Dynamic characteristics

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input capacitance	Ciss	f = 1MHz, V_{DS}=-25V	-	8500	-	pF
Output capacitance	Coss		-	290	-	
Reverse transfer capacitance	Crss		-	195	-	
Gate Risistance	Rg	f = 1MHz	-	4		Ω
Total gate charge	Qg	V_{DD} = -15V, I_D = -10A, V_{GS} = -10V	-	112	-	nC
	Qg(-4.5v)		-	55	-	
Gate - Source charge	Qgs		-	24	-	
Gate - Drain charge	Qgd		-	12	-	
Turn-ON Delay time	$t_{D(on)}$	V_{GS}=-10V,V_{DS}=-15V, R_G =3.3Ω, I_D =-10A	-	16	-	ns
Turn-ON Rise time	t_r		-	55	-	ns
Turn-Off Delay time	$t_{D(off)}$		-	180	-	ns
Turn-Off Fall time	t_f		-	85	-	ns
Reverse Recovery Time	t_{RR}	V_{DD}=-20V, dI_S/dt = 100A/us, I_S=-20A	-	220	-	ns
Reverse Recovery Charge	Q_{RR}		-	940	-	nC

Fig.1 Gate-Charge Characteristics

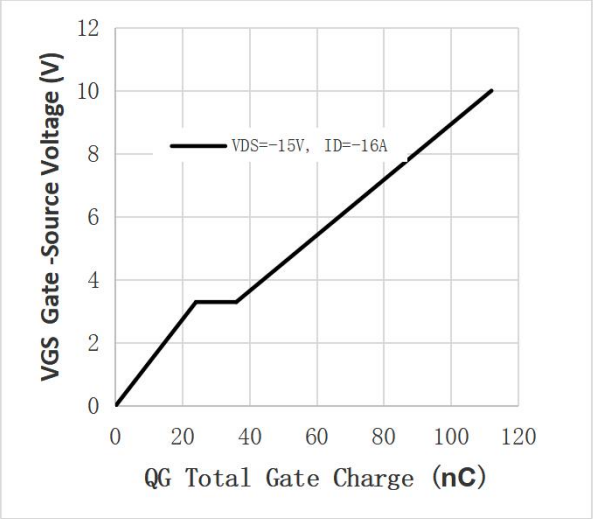


Fig.2 Capacitance Characteristics

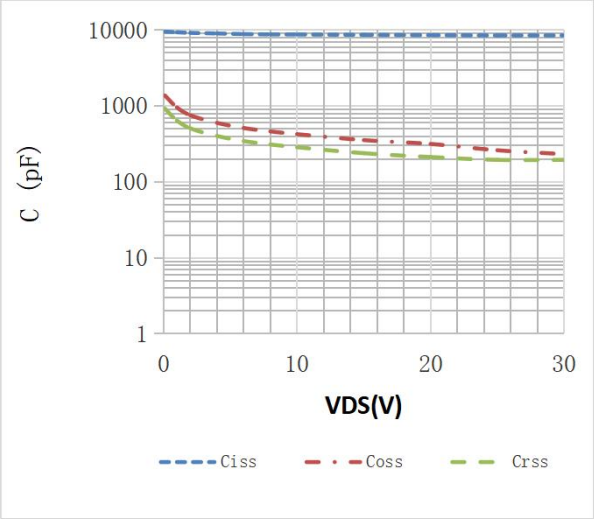


Fig.3 Power Dissipation

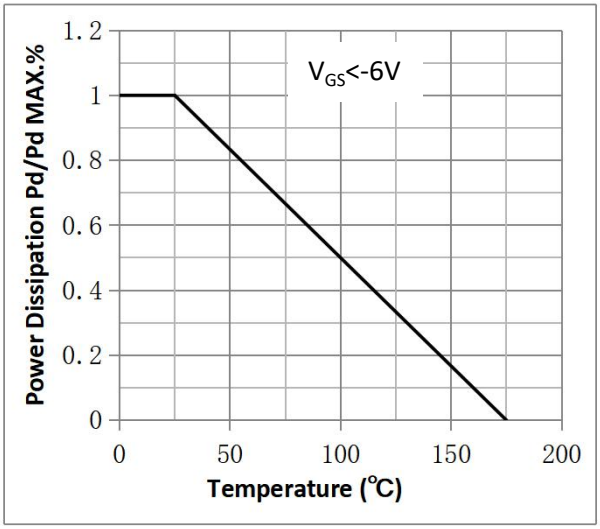


Fig.4 Typical output Characteristics

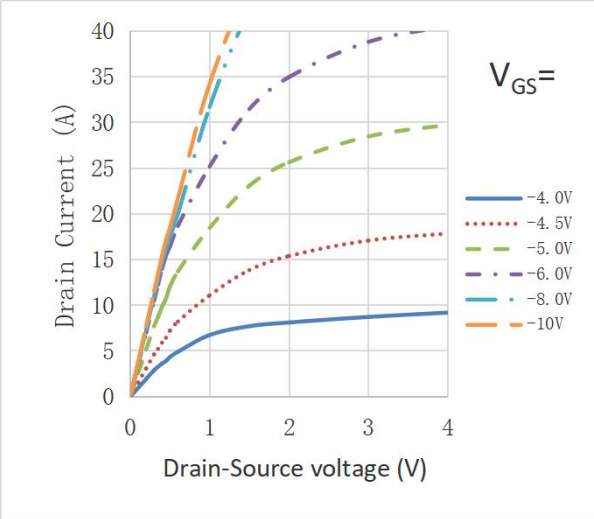


Fig.5 Threshold Voltage V.S Junction Temperature

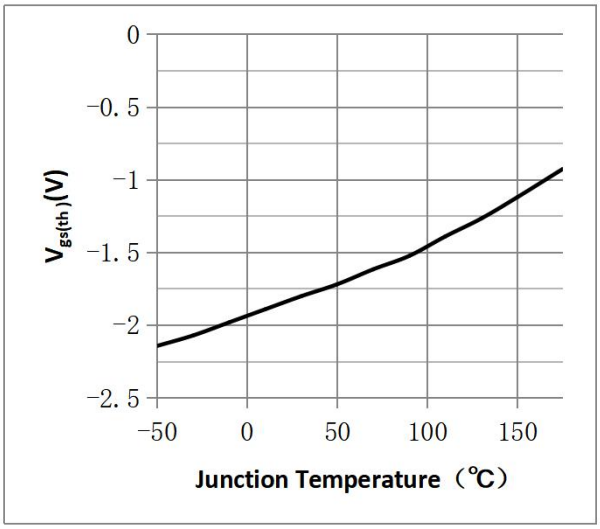


Fig.6 Resistance V.S Drain Current

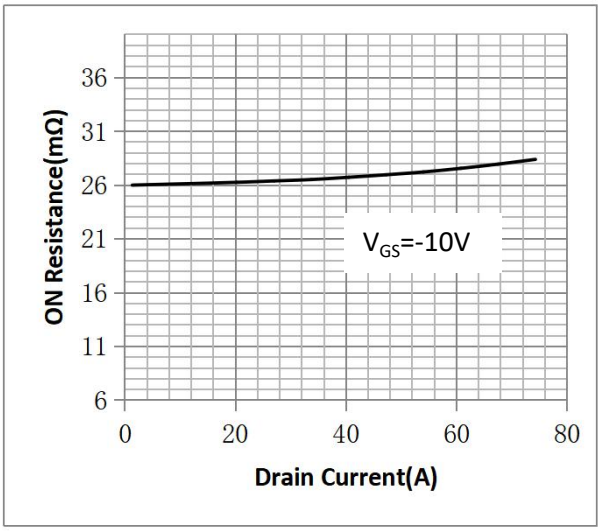


Fig.7 On-Resistance VS Gate Source Voltage

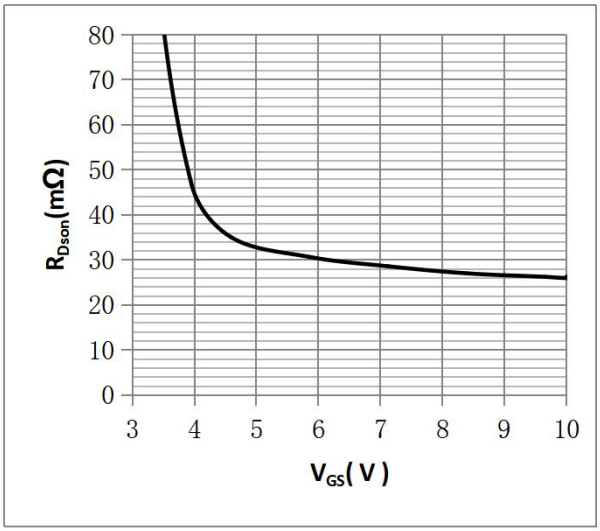


Fig.8 On-Resistance V.S Junction Temperature

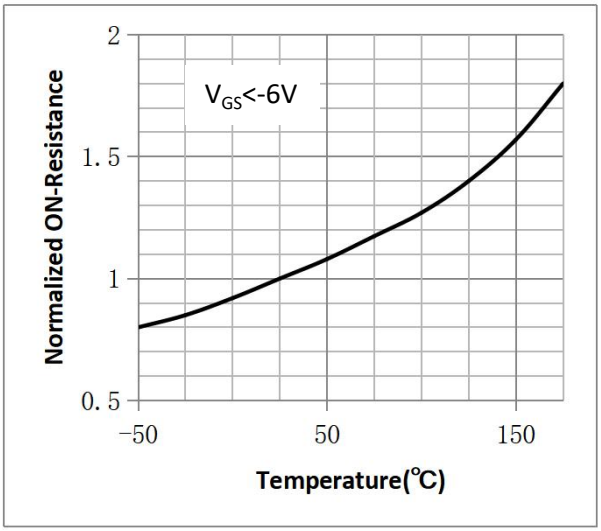


Figure 9. Diode Forward Voltage vs. Current

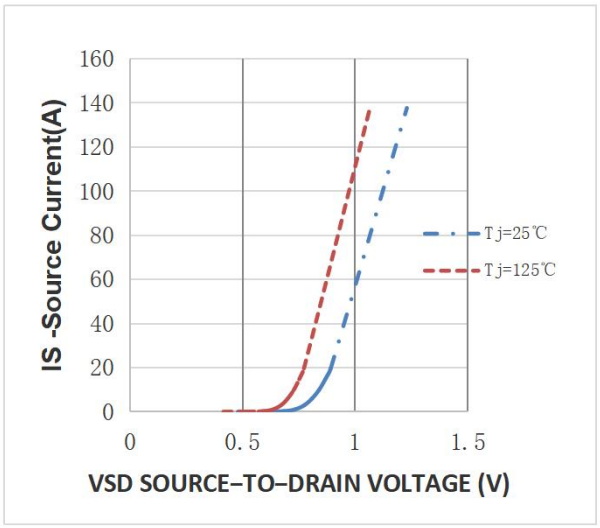


Figure 10. Transfer Characteristics

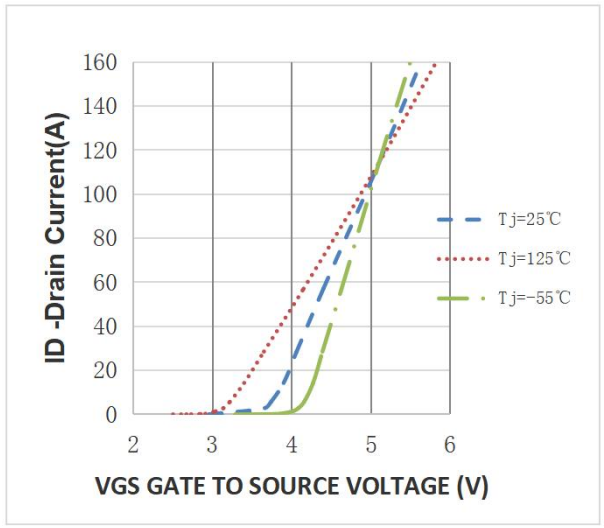


Fig.11 Safe Operating Area

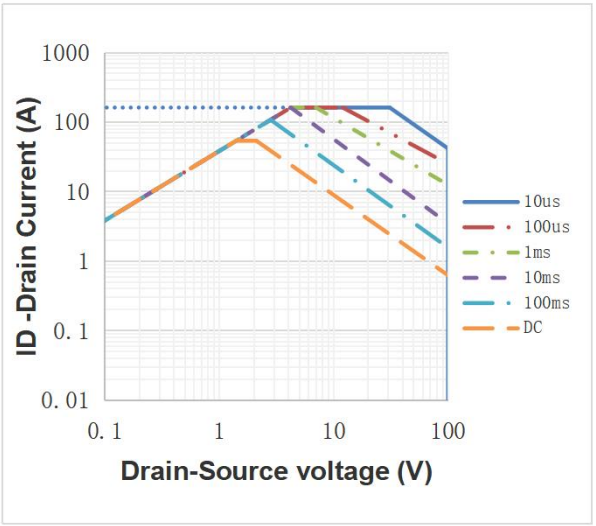
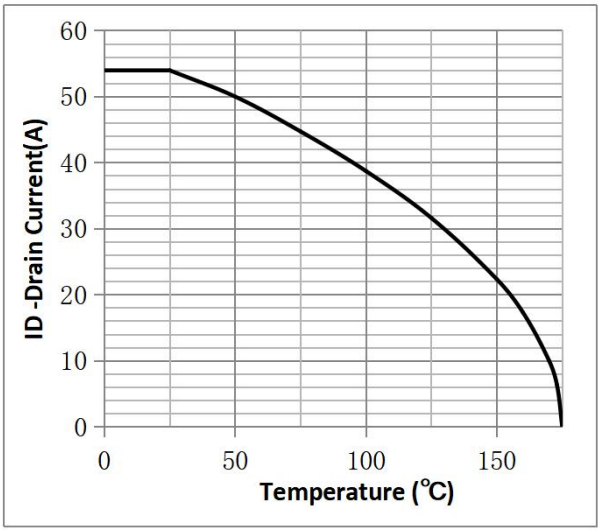
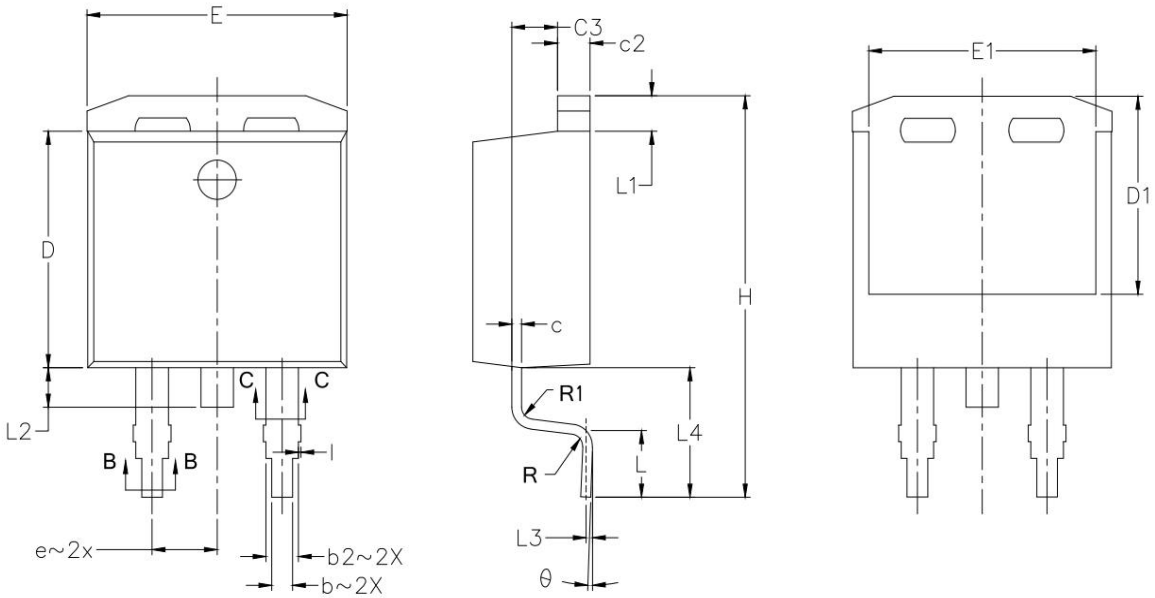
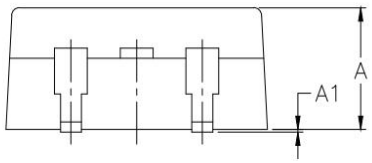


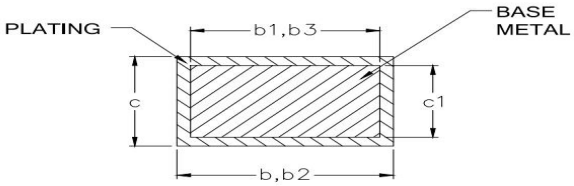
Fig.12 ID vs. Case Temperature③



●TO-263 Package Outline







SYMBOLS	COMMON			
	MM		INCH	
	MIN.	MAX.	MIN.	MAX.
A	4.064	4.826	0.160	0.190
A1	0.000	0.254	0.000	0.010
b	0.508	0.991	0.020	0.039
b1	0.508	0.889	0.020	0.035
b2	1.143	1.778	0.045	0.070
b3	1.143	1.727	0.045	0.068
c	0.381	0.737	0.015	0.029
c1	0.381	0.584	0.015	0.023
c2	1.143	1.651	0.045	0.065
D	8.382	9.652	0.330	0.380
D1	6.858	——	0.270	——
E	9.652	10.668	0.380	0.420
E1	6.223	——	0.245	——
e	2.540 BSC.		0.100 BSC.	
H	14.605	15.875	0.575	0.625
L	1.778	2.794	0.070	0.110
L1	——	1.676	——	0.066
L2	——	1.778	——	0.070
L3	0.254 BSC		0.010 BSC	
L4	4.780	5.280	0.188	0.208
R	0.460 TYP		0.018 TYP	
R1	0.460 TYP		0.018 TYP	
θ	0°	8°	0°	8°
C3	1.68	1.88	0.0661	0.0740
I	-	0.100	-	0.0039

NOTES:
1.Dimension D & E Does Not Include Mold Flash
2.Dimension b2 Does Not Include Protrusions

Note:

① Pulse : VGS=+20V/-20V, Duty cycle=50%,Tj=175℃, t=1000 hours; For DC， the following test conditions can be passed: VGS=-20V/+10V, Tj=175℃, t=1000 hours；

② Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate；

③Practically the current will be limited by PCB, thermal design and operating temperature. VGS=-10V.

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Revision History

Version	Date	Change
A	2021.2.3	
B	2022.9.7	1.Add Reach,HF figure,2.ID modify